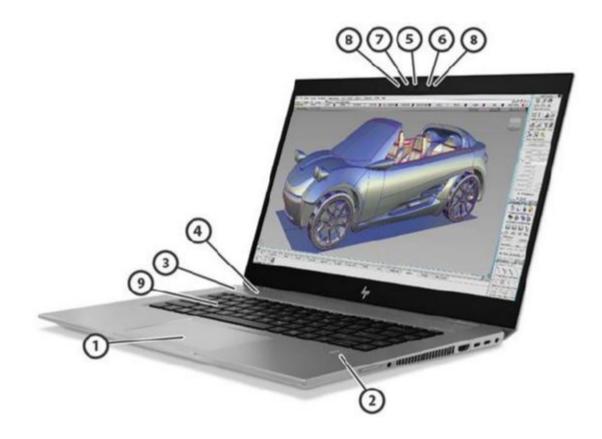
### Overview

## **HP ZBook Studio G5 Mobile Workstation**



- 1. Clickpad
- 2. Fingerprint sensor
- 3. Power button
- 4. Speakers
- 5. Camera

#### FRONT VIEW

- 6. IR Camera
- 7. HP Privacy Shutter
- 8. Microphone
- 9. Collaboration Keys

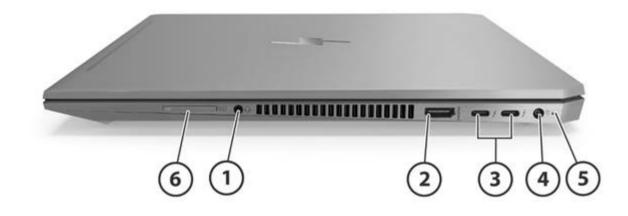
Overview



#### LEFT VIEW

1. USB 3.0

- 2. USB 3.0 charging port
- 3. Security cable slot



- 1. Stereo microphone in / headphone-out combo jack
- 2. HDMI 2.0
- 3. 2Thunderbolt<sup>™</sup> 3 ports

- VIEW
- 4. Power connector
- 5. Power LED
- 6. SD Card Reader

RI

## Overview



**BOTTOM VIEW** 

1. Fan Venting

## 2. Speakers

## At A Glance

- Thinner, lighter, smaller chassis over prior generation, 15"? diagonal and 4.4 pounds. Designed with full sized chicklet, optional backlit keyboard with numeric keyboard. Spill resistant design with drain.
- Designed to pass MIL-STD-810G testing\*.
- Workstation-caliber NVIDIA<sup>®</sup> Quadro<sup>®</sup> discrete graphics: NVIDIA<sup>®</sup> Quadro<sup>®</sup> P1000 4GB GDDR5; NVIDIA<sup>®</sup> Optimus
- Intel Integrated graphics: Intel<sup>®</sup> HD Graphics 630 integrated on Core<sup>™</sup> i7. Intel<sup>®</sup> HD Graphics P630 integrated on Xeon<sup>®</sup> processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures
- Choice of up to six core 8th Generation Intel<sup>®</sup> Core<sup>TM</sup> i7 and Intel<sup>®</sup> Core<sup>TM</sup> i5 six-core or six-core 8<sup>th</sup> Generation Intel<sup>®</sup> Xeon<sup>®</sup> processors.
- Intel<sup>®</sup> Core<sup>TM</sup> i7 with vPro<sup>TM</sup>, Intel<sup>®</sup> Core<sup>TM</sup> i5 with vPro<sup>TM</sup> technology or Intel<sup>®</sup> Xeon<sup>®</sup> with vPro<sup>TM</sup> technology (optional)
- HP Performance Advisor for optimal configuration, stability, compatibility and best performance
- Up to two SODIMMs supporting up to 32 GB DDR4-2667MHz dual-channel memory. ECC memory available with Intel® Xeon® processors Featuring HP Collaboration Keyboard with Clickpad to manage most commonly used conferencing functions with a single keystroke
- Innovative world-facing third mic improves inbound ambient noise cancellation
- Supports multi-display, including up to three (3) displays without a docking solution, with hybrid graphics enabled. Supports five (5) displays with HP Thunderbolt<sup>TM</sup> Dock G2 (sold separately), with hybrid graphics enabled.
- Two (2) Thunderbolt<sup>™</sup> 3 ports (supporting DP 1.3, USB 3.1, PCIe Gen 3 devices) on the new USB-C<sup>™</sup> connector, for high speed data/video/audio transfer support.
- Bang and Olufsen audio optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal clear dialog without distortion at high volume, and new discrete amp.
- HP Long life battery solution: 4-cell (64 WHr) or 6-cell (96 WHr) supporting HP Fast Charge
- Widescreen 15.6-inch diagonal LED-backlit display:
  - o FHD IPS eDP + PSR anti-glare, 400 nits with ambient light sensor (1920x1080)
  - o HP Sure View FHD IPS eDP + PSR anti-glare 650nits (1920x1080)
  - o UHD IPS eDP + PSR anti-glare, 400 nits with ambient light sensor (3840x2160)

Overview

- o HP DreamColor Technology UHD IPS eDP + PSR anti-glare, 600 nits 100% Adobe RGB (3840x2160)
- Wireless connectivity options:
  - Intel<sup>®</sup> Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (vPro<sup>TM</sup>)or, Intel<sup>®</sup> Du Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth 5.0 combo adaptor (non-vPro<sup>TM</sup>)
     Optional integrated wireless 4G (LTE) mobile broadband module support
- Three (3) dedicated drive slots, two (2) M.2 slots, and one (1) 2.5"? drive bays supporting up to 6TB of storage
- Enterprise grade security with HP SureStart Gen4, HP Privacy Camera, HP Sure View, HP Sure Run, HP Sure Recover, SmartCard Reader and Fingerprint reader

\*MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

#### NOTE: See important legal disclosures for all listed specs in their respective features sections.

### **OPERATING SYSTEM**

Preinstalled	Windows <sup>®</sup> 10 Pro 64 - HP recommends Windows 10 Pro*		
	Windows 10 Pro for Workstations 64*		
	Windows <sup>®</sup> 10 Home 64 Plus*		
	Windows <sup>®</sup> 10 Home 64 Advanced *		
	FreeDOS 2.0		
Supported	Windows <sup>®</sup> 10 Enterprise 64*		
	RedHat® Enterprise Linux® (REHL) 7		
	Ubuntu Linux 16.04		
[PJ1] [PJ2]	For additional Linux OS information, please reference our Linux Hardware Matrix: http://h10032.www1.hp.com/ctg/Manual/c00060684.pdf		

\*Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchasec hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com

## **PROCESSOR\***

8th Generation Intel® Core<sup>TM</sup> i5+ 8300H (Core i5 and 16GB Intel® Optane<sup>TM</sup> memory) with Intel® UHD Graphics 630 ( 2.3 GHz ( up to 4.0 GHz )/2667 MHz/ 8 MB L3 cache/45W )

8th Generation Intel<sup>®</sup> Core<sup>™</sup> i5 8300H with Intel<sup>®</sup> UHD Graphics 630 (2.3 GHz (up to 4.0 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core<sup>TM</sup> i5+ 8400H vPro<sup>TM</sup> processor (Core i5 and 16GB Intel® Optane<sup>TM</sup> memory) with Intel® UHD Graphics 630 ( 2.5 GHz ( up to 4.2 GHz )/2667 MHz/ 8 MB L3 cache/45W )

8th Generation Intel<sup>®</sup> Core<sup>™</sup> i5 8400H vPro<sup>™</sup> processor with Intel<sup>®</sup> UHD Graphics 630 ( 2.5 GHz ( up to 4.2 GHz )/2667 MHz/ 8 MB L3 cache/45W )

8th Generation Intel® Core<sup>TM</sup> i7+ 8750H (Core i7 and 16GB Intel® Optane<sup>TM</sup> memory) with Intel® UHD Graphics 630 (2.2 GHz ( up to 4.1 GHz )/2667 MHz/ 9 MB L3 cache/45W )

8th Generation Intel® Core™ i7 8750H with Intel® UHD Graphics 630 (2.2 GHz (up to 4.1 GHz )/2667 MHz/ 9 MB L3 cache/45W )

8th Generation Intel<sup>®</sup> Core<sup>TM</sup> i7+ 8850H vPro<sup>TM</sup> processor (Core i7 and 16GB Intel<sup>®</sup> Optane<sup>TM</sup> memory) with Intel<sup>®</sup> UHD Graphics 630 ( 2.6 GHz ( up to 4.3 GHz )/2667 MHz/ 9 MB L3 cache/45W )

8th Generation Intel<sup>®</sup> Core<sup>TM</sup> i7 8850H vPro<sup>TM</sup> processor with Intel<sup>®</sup> UHD Graphics 630 ( 2.6 GHz ( up to 4.3 GHz )/2667 MHz/ 9 MB L3 cache/45W )

Intel<sup>®</sup> Xeon<sup>®</sup> E-2176M vPro<sup>TM</sup> processor with Intel<sup>®</sup> UHD Graphics P630 (2.7 GHz (up to 4.4 GHz)/2667 MHz/12 MB L3 cache/45W) Intel<sup>®</sup> Xeon<sup>®</sup> E-2186M vPro<sup>TM</sup> processor with Intel<sup>®</sup> UHD Graphics P630 (2.9 GHz (up to 4.6 GHz)/2667 MHz/12 MB L3 cache/45W)

\* Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance \*\*Intel® Optane<sup>TM</sup> memory system acceleration does not replace or increase the DRAM in your system.

\*\*\*Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

**NOTE:** In accordance with Microsoft's support policy, HP does not support the Windows<sup>®</sup> 8 or Windows 7 operating system on products configured with Intel<sup>®</sup> and AMD 7th generation and forward processors or provide any Windows<sup>®</sup>8 or Windows 7 drivers c http://www.support.hp.com

### CHIPSET

Mobile Intel<sup>®</sup> CM246

# INTEL® CORE<sup>TM</sup> I5 WITH VPRO/CORE I7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel<sup>®</sup> Core<sup>TM</sup> i5 with vPro<sup>TM</sup>, Core<sup>TM</sup> i7 with vPro<sup>TM</sup> and XEON<sup>®</sup> with vPro<sup>TM</sup> technology is a selectable feature that is available on units configured with select processors, a qualified Intel<sup>®</sup> WLAN module and a preinstalled Windows<sup>®</sup> operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel<sup>®</sup> Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off\* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

\* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPI corporate network connection which is either cable or wireless LAN.

**NOTE:** Some functionality of Intel<sup>®</sup> Core<sup>TM</sup> i5 with vPro<sup>TM</sup>/Core<sup>TM</sup> i7 with vPro<sup>TM</sup>/Xeon<sup>®</sup> with vPro<sup>TM</sup> technology, such as Intel<sup>®</sup> Active Management technology and Intel<sup>®</sup> Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel<sup>®</sup> Core<sup>TM</sup> i5 with vPro<sup>TM</sup>/Core i7 with vPro<sup>TM</sup>/XEON<sup>®</sup> with vPro<sup>TM</sup> technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determine

## GRAPHICS

#### Integrated

Intel® UHD graphics 630<sup>1,2</sup> Intel® UHD graphics P630<sup>1,2</sup>

#### Discrete<sup>3</sup>

NVIDIA® Quadro® P1000 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NOTE 1: UHD content required to view UHD images

**NOTE 2:** Intel<sup>®</sup> UHD graphics 630 is configurable as a standalone graphics option; Intel<sup>®</sup> UHD graphics P630 only used when NVIDIA<sup>®</sup> Optimus<sup>TM</sup> Technology is enabled.

**NOTE 3:** NVIDIA<sup>®</sup> Quadro<sup>®</sup> mobile professional graphics support up to four independent displays when using a HP ZBook Dock wit Thunderbolt<sup>TM</sup> 3 (sold separately) or DP 1.2 hubs with MST.

**NOTE:** Intel<sup>®</sup> UHD Graphics 630 integrated on Core<sup>TM</sup> i7 and Core<sup>TM</sup> i5 processors. Intel<sup>®</sup> UHD Graphics P630 integrated on Xeon<sup>®</sup> processors.

#### DisplayPort<sup>™</sup> 1.3 protocol features supported on Thunderbolt<sup>™</sup> 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt<sup>TM</sup> port with the use of a certified dongle.
- DisplayPort<sup>TM</sup> monitors capable of supporting DisplayPort<sup>TM</sup> 1.3 may be directly attached to the Thunderbolt<sup>TM</sup> port to achieve HBR2 with the use a dongle.
- DisplayPort<sup>TM</sup> monitors capable of supporting DP 1.3 may be directly attached to the Thunderbolt<sup>TM</sup> port to achieve HBR2 with the use a dongle.
- Thunderbolt<sup>TM</sup> 3 enabled monitors may be directly attached to the Thunderbolt<sup>TM</sup> port to achieve HBR2 and MST.
- DisplayPort<sup>™</sup> 1.3 MST feature ("daisy-chain" feature) is supported through Thunderbolt<sup>™</sup> 3 port on Thunderbolt<sup>™</sup> 3 enabled devices or DisplayPort<sup>™</sup> 1.3 monitors (requires monitor with DisplayPort<sup>™</sup> 1.3 MST capability) with the use of a dongle.

- Up to 2 streams (eight lanes) of DisplayPort<sup>™</sup> 1.3 are supported over a single Thunderbolt<sup>™</sup> 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt<sup>™</sup> 3 port. (Requires Intel<sup>®</sup> certified Thunderbolt<sup>™</sup> cable).
- DisplayPort<sup>™</sup> 1.3 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

\*Thunderbolt<sup>TM</sup> 3 is superset port supporting DisplayPort<sup>TM</sup> 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C<sup>TM</sup> connector. Install all the latest drivers for your Thunderbolt<sup>TM</sup> device before connecting the device to the Thunderbolt<sup>TM</sup> port. Thunderbolt<sup>TM</sup> cable and Thunderbolt<sup>TM</sup> device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt<sup>TM</sup> Certified for Windows, see https://Thunderbolttechnology.net/products.

#### **Multi-Display Support**

#### Without HP Thunderbolt Dock G2:

HP ZBook Studio with hybrid graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. These three displays are the internal panel plus two external displays connected two of the three following ports: HDMI 2.0, Thunderbolt<sup>TM</sup> 3, Thunderbolt<sup>TM</sup> 3. HP ZBook Studio configuration with Intel<sup>®</sup> integrated graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. Any three display combination of the system panel plus 2 of the following HDMI, Thunderbolt<sup>TM</sup> 3, Thunderbolt<sup>TM</sup> 3.

#### With HP Thunderbolt Dock G2:

The HP Thunderbolt Dock G2 has Thunderbolt<sup>TM</sup> 3 port, VGA, two DisplayPort<sup>TM</sup> 1.3, and a USB-C port. When used together with the HP ZBook Studio configuration with hybrid graphics, a maximum of five independent displays are supported. These five displays are internal panel, one external display connected to the system's HDMI port and four external displays connected to the ZBook dock's Thunderbolt<sup>TM</sup> 3, VGA, and two DisplayPort<sup>TM</sup> ports. When used together with the HP ZBook Studio configuration with Intel<sup>®</sup> integrated graphics, a maximum of three independent displays are supported. Any three display combination of the system panel, system ports and ZBook Dock ports.

### DISPLAY

Internal

- 15.6"? diagonal FHD IPS eDP + PSR anti-glare LED-backlit, 400 nits with ambient light sensor (1920x1080)
- 15.6"? diagonal UHD IPS eDP + PSR anti-glare LED-backlit, 400 nits with ambient light sensor (3840x2160)
- HP DreamColor Display, 15.6"? diagonal UHD IPS eDP + PSR anti-glare, RG phosphors LEDbacklit, 600 nits, 100% AdobeRGB with 10-bit color (3840x2160)
- HP Sure View Display 15.6"? diagonal FHD IPS eDP+PSR LED-backlit, 650 nits (1920x1080)

**NOTE:** Resolutions are dependent upon monitor capability, and resolution and color depth settings.

### **STORAGE AND DRIVES\***

Three (3) dedicated drive slots, two (2) M.2 slots, and one (1) 2.5" ?drive bays supporting up to 6TB of storage **Choose up to 2 M.2 drives:** 

SATA SED Solid State Drives\*

256 GB SATA Self Encrypting Drive(SED) 16GB Intel® Optane Cache (Must be configured with HDD)

#### HP Z Turbo Drives (NVMe PCIe SSD)

256GB PCIe (NVMe) TLC Solid State Drive 512GB PCIe (NVMe) TLC Solid State Drive 1 TB PCIe (NVMe) TLC Solid State Drive 2 TB PCIe (NVMe) TLC Solid State Drive 256GB PCIe (NVMe) TLC Self Encrypting Drive (SED) Solid State Drive 512GB PCIe (NVMe) TLC Self Encrypting Drive (SED) Solid State Drive Choose up to 1 2.5"? Storage Bay Drives\* 2 TB 5400 rpm SATA Hard Disk Drive 500 GB SATA SSHD (Hvbrid Drive) (8 GB cache) 1 TB SATA SSHD (Hybrid Drive) (8 GB cache) 2 TB SATA SSHD (Hybrid Drive) (8 GB cache) 500 GB 7200 rpm SATA Hard Disk Drive 1 TB 7200 rpm SATA Hard Disk Drive 500 GB 7200 rpm SATA SED (Self Encrypting Drive) Hard Disk Drive 500 GB 5400 rpm SATA FIPS 140-2 SED Hard Disk Drive 256GB SATA Solid State Drive 1 TB SATA Solid State Drive

#### HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses three-axis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. TI digital accelerometer temporarily halts all data transfer and parks the hard drive when abrupt motion is detected.

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

### **DRIVE CONTROLLERS**

2.5"? Storage Bays and M.2 Storage Bay (SATA): NVMe M.2 2280 SSD: RAID: **NOTE:** Raid 0, 1 supported only on SATA drives. SATA-3 or SATA-2 for HDD and SATA-3 for SSD PCIe Gen 3 x4 0, 1 supported\*

## Features

## MEMORY

#### Standard

32 GB DDR4 ECC or Non-ECC SDRAM (With transfer rates up to 2667MT/s<sup>1</sup>) Two SODIMM slots supporting dual-channel memory 4 GB, 8GB and 16 GB SODIMMs (for Intel<sup>®</sup> Core<sup>TM</sup> Processors) 8GB and 16 GB ECC SODIMMs (for Intel<sup>®</sup> XEON<sup>®</sup> Processors)

#### Maximum

Upgradeable to 32 GB with optional 16 GB SODIMMs in 2 slots

#### **Dual-channel**

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE 1: Only 2 DIMM configurations run at 2667 MHz.

**NOTE:** Maximum memory capacities assume Windows 64-bit operating systems. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

## **NETWORKING/COMMUNICATIONS**

#### Wireless

Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth<sup>®</sup> is also available (factory configurable only) and can be combined with any of the supported wireless LAN options.

#### 802.11 Wireless LAN options\*\*

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo; Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo, non-vPro<sup>TM</sup>

#### Near Field Communication<sup>1</sup>

NFC Mirage WNC XRAV-1 (NXP NPC300 I2C 10mmx17mm)

\*\*Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are no final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

<sup>1</sup>Sold separately or as an optional feature.

## AUDIO/MULTIMEDIA

#### Audio<sup>1</sup>

Audio custom-tuned by HP and Bang & Olufsen, dual stereo speakers Dual array digital microphone Optional World Facing microphone Functions keys for volume up and down Combo microphone/headphone jack HD audio; featuring HP Noise Cancellation Software, HP Clear Sound Amp and Skype for Business Certification

#### Webcam\*,\*\*

Optional HP Privacy Camera (720p HD webcam)

Optional HP Privacy Camera (720p HD webcam) IR camera for face authentication with Windows Hello

- Privacy Camera features sliding camera shutter (non-touch only)
- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range
- \* HD content required to view HD images.

\*\*Optional or add-on feature.

Note 1: Dual-microphone array when equipped with optional webcam and optional world facing microphone

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Collaboration Keyboard to manage the most common collaboration function with a keystroke. Backlit keyboard with Functior key control to toggle backlit brightness setting - off/full/half brightness. The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 100-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

#### **Pointing Devices**

Clickpad with multi-touch gestures enabled, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

#### **Buttons and Function Keys**

Discrete buttons provide easy access to the following features:

- F1 Display Switching
- F2 HP SureView (if configured)
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio mute
- F6 Volume down
- F7 Volume up
- F8 Microphone mute
- F9 Keyboard backlight
- F10 NumLock

### Features

- F11 Wireless on/off
- F12 Calendar
- F13 Share screen
- F14 Call
- F15 End Call

# SOFTWARE AND SECURITY

#### **Workstation ISV Certifications**

See the latest list of certifications at: http://www.hp.com/go/isv

#### HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: http://www.hp.com/go/RGS

#### **HP Performance Advisor**

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: http://www.hp.com/go/performanceadvisor

#### **Standard Security Features**

HP BIOSphere Gen4<sup>1</sup> HP DriveLock & Automatic DriveLock BIOS Update via Network HP BIOS Config Utility (BCU)9 Secure Erase<sup>3</sup> Absolute persistence module<sup>7</sup> Pre-boot Authentication Power-on authentication SATA 0,1 port disablement (viaBIOS) **RAID** configurations Serial, USB enable/disable (viaBIOS) Power-on password (viaBIOS) Setup password (viaBIOS) Support for chassis padlocks and cable lock devices HP Sure Click<sup>4</sup> **One-Step Logon** Security lock slot Support for Intel<sup>®</sup> AT TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified) Measured Boot **HP Sure Click** HP Sure Start G4<sup>2</sup> HP Sure Run<sup>5</sup> HP Sure Recover<sup>6</sup> **Device Access Manager** HP Security Manager (including Credential Manager and Password Manager<sup>12</sup>) Microsoft Defender 8 HP Host Based Mac Address HP Client Catalog <sup>9</sup> HP Driver Packs<sup>9</sup> HP System Software Manager (SSM) <sup>9</sup> HP Manageability Integration Kit for Microsoft SCCM<sup>10</sup>

#### трм

Model: Infineon SLB9670 Version: 7.62.3126.0 Revision: TPM 2.0 FIPS 140-2 Compliant: Yes (select models only)

#### **Optional Security Features**

HP Fingerprint Sensor (optional)<sup>11</sup>

IR Camera with Windows Hello

Absolute Data Protect\* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HF Mobile Broadband Module.

\* The Absolute Data Protect agent is shipped turned off, and must be activated by customers when they purchase a subscription Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside t U.S.

- 1. HP BIOSphere Gen4 requires Intel® or AMD 8th generation processors.
- 2. HP Sure Start Gen4 is available on HP Z Workstations products equipped with 8th generation Intel® or AMD processors.
- 3. HP Secure Disk Erase is for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 4. HP Sure Click is available on select platforms only as a web-download from the HP Support website, is preinstalled on selec HP platforms and supports Microsoft<sup>®</sup> Internet Explorer and Chromium<sup>TM</sup>. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available.
- 5. HP Sure Run is available on HP Elite products equipped with Intel® or AMD® 8th generation processors
- 6. HP Sure Recover is available on HP Elite PCs with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid log of data
- 7. BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 8. Opt in and internet connection required for updates
- 9. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 10. HP Manageability Integration Kit can be downloaded from
- http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 11. Finger Sensor is optional
- 12. HP Password manager requires Windows.

#### Linux Hardware Matrix for HP Workstations

RHEL 7 certifications pending. As of this edition of this matrix, some Enterprise-class Linux releases enable the Intel<sup>®</sup> architecture used in this system. HP considers enablement for the CPU, chipset, and the on-board LAN to be minimum requirements.

Product Items/Features (Blank box indicates the listed component is NOT functional w/ as-is O**RHEL 7.3 or RHEL 7.3 or** 

	later (x86_64)	later (x86_64)
HP Workstation Base System		
Base system includes: Chassis, System Board, Power Supply, etc.	•	
HP Localization Kit	1	1
All Supported Processors		
All supported 7th generation Intel $^{\circ}$ Core <sup>TM</sup> i7, i5 and Xeon $^{\circ}$ processors	•	•
System RAM		
Minimum (GB)	4GB	4GB
Maximum (GB)	32GB	32GB
Graphics Card (Video Card)		
Intel <sup>®</sup> UHD integrated graphics 630 on Core <sup>TM</sup> i7 processors	5	5

eatures		
Intel® UHD integrated graphics P630 on Xeon® processors	5	5
NVIDIA <sup>®</sup> Quadro <sup>®</sup> P1000 with 4 GB of graphics memory	6	6
Display - internal panel		
15.6"? diagonal FHD IPS eDP anti-glare LED-backlit, 220 nits (1920x1080)	•	
15.6"? diagonal FHD IPS eDP + Panel Self Refresh (PSR) anti-glare LED-backlit, 400 nits with ambient light sensor (1920x1080)		
HP DreamColor Display, 15.6"? diagonal UHD IPS eDP + PSR anti-glare, RG phosphors - LED- backlit, 600 nits, 100% AdobeRGB with 10-bit color (3840x2160)		•
HP Sure View Display 15.6"? diagonal FHD IPS eDP+PSR LED-backlit Touch-screen with Corning Gorilla Glass 4, 650 nits (1920x1080)	7	7
Hard Disks		
All supported 2.5" AHCI SATA Hard Disk Drives	•	
All Supported M.2 Solid State Drives	•	
All Supported HP Z Turbo Drive NVMe PCIe-attached storage Solid State Drives	•	
All Supported M.2 AHCI SED Solid State Drives	8	8
Onboard Components		
Wired LAN - Intel® i219LM Gigabit Ethernet	•	
Onboard Audio (Conexant codec)	•	
Onboard SATA RAID	2	2
Intel® dual-band wireless AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth (vPro & non-vPro)	•	•
HP HD (720p) webcam	•	•
Thunderbolt 3 <sup>™</sup> ports	3	3
USB 3.0 ports	·	•
Input/Output Devices		
Touchpad	•	•
TPM Module	4	4
HP Media Card Reader	•	•
External HDMI port	·	•
Dock Options		
Zbook dock with Thunderbolt 3 <sup>TM</sup>	9,11	10,11
HP USB Type-C Elite dock		

**Note 1:** Typical Linux distributions support many possible localizations. If you're installing the OS yourself, you can make selections for language and keyboard layout during that process. For a pre-loaded Linux OS, similar choices can be made during the "firstboot" process. In some cases, extra font packages may be available. HP Workstations can be ordered with a variety of localization options that may vary by platform.

**Note 2:** Hardware RAID is not supported on SATA drives. Software RAID is available in most Linux OSes and can be used with SAT or PCIe storage devices.

**Note 3:** Newer Linux kernels may provide device functionality through the Thunderbolt ports. Such kernels are likely to be available in leading-edge distributions, but inclusion of the support with any Enterprise Linux distribution is at the distributor's discretion.

Note 4: Support for the TPM or other security devices varies by OS distribution.

**Note 5:** The Intel<sup>®</sup> HD graphics works with the in-box frame-buffer drivers. Support for the "native" Intel<sup>®</sup> driver on v7 processor (Kaby lake) is not available for most release streams as of this edition of the table.

Note 6: HP recommends use of Nvidia driver 375.66 (or newer) on Nvidia graphics options.

**Note 7:** As of this edition of the table, only basic touch capability was available in most Linux desktop managers and no desktops are optimized for a satisfactory touch experience.

**Note 8:** SED drives work with Linux. There is, however, no Linux support available for manipulating encryption settings via the Opal API.

**Note 9:** The Thunderbolt dock is compatible with RHEL 7 on this zbook model, starting with RHEL 7.3.

**Note 10:** The Thunderbolt dock is compatible with Ubuntu 16.04, starting with 16.04.1. The one known limitation is that the audio headphone jack does not work.

**Note 11:** With Nvidia-based configurations, it is recommended to use the Nvidia closed source driver when using externally connected displays. It is not currently recommended to use the dock with AMD graphics options at this time.

## **HP CENTRAL MANAGEMENT**

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, devic and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidently compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

An optional fingerprint reader helps keep your identity secure. The security cable slot helps keep your notebook physically secure

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.

### POWER

#### **Power Supply**

HP 150W Slim Smart AC adapter (153 x 66 x 22 mm)

#### **Primary Battery**

HP Long Life 4-cell prismatic Battery (64 WHr) \*

HP Long Life 6-cell Polymer Battery (96 WHr) \*

NOTE: Battery is internal and not replaceable by the customer

**Battery Life** Battery life up to TBD\*\* Battery life up to TBD\*\*

# System Standby Time

Up to TBD weeks\*\*\*

\* Available with 3-year limited warranty only

\*\* Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark https://bapco.com/products/mobilemark-2014/ for additional details.

### Features

\*\*\* Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity the battery will naturally decrease with time and usage.

#### **Power Conservation**

NVIDIA<sup>®</sup> Optimus or AMD Enduro<sup>TM</sup> technology Hibernation Standby ACPI compliance

## ENVIRONMENTAL

US ENERGY STAR <sup>®</sup> IT ECO declaration EPEAT<sup>®</sup> registered\* Low Halogen\*\*

\* EPEAT <sup>®</sup> registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options. \*\*External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

## WEIGHTS & DIMENSIONS

Weight Starting at 4.4 lb. (2.0kg.)

#### **Dimensions** (w x d x h)

14.17 in x 9.65 in x 0.35 in (front) - 0.69 in (rear) 360 mm x 254 mm x 8.8 mm (front) - 17.4 mm (rear)

**Note:** Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core CPU, UHD, 4-cell battery, Intel<sup>®</sup> UHD graphics, no FPR, 8GB x 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, no BT

# PORTS/SLOTS

## Ports

Left side: (1) USB 3.0 Charging Port (1) USB 3.0 (1) Security lock slot

### **Right side:**

(1) HDMI 2.0
 (2) Thunderbolt<sup>TM</sup> 3\* (Supporting DisplayPort<sup>TM</sup> 1.3, USB 3.1 Gen2, PCIe Gen 3 devices)
 (1) Stereo microphone in / headphone-out combo jack
 (1) Power Connector
 (1) Full-size SD Card Reader

#### Thunderbolt<sup>™</sup> 3

Thunderbolt<sup>TM</sup>3 ports supports DisplayPort<sup>TM</sup> 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort<sup>TM</sup> displays, devices, and cables. Install all the latest drivers for your Thunderbolt<sup>TM</sup> device before connecting the device to the Thunderbolt<sup>TM</sup> port. Thunderbolt<sup>TM</sup> cable and Thunderbolt<sup>TM</sup> device (sold separately) must be compatible with Windows<sup>®</sup>. To determine whether your device is Thunderbolt<sup>TM</sup> Certified for Windows, see https://thunderbolttechnology.net/products.

#### **Digital Media Slots**

(1) SD UHS-II Flash Media slot (Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC

## **SERVICE AND SUPPORT**

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional<sup>\*</sup> HP Car Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/cpc.

\*Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

System Technical Specifications

## SYSTEM UNIT

<b>Stand-Alone Power</b> <b>Requirements</b> (AC Power)	Nominal Operating Voltage	19.5 V	
	Average Operating Power	DreamColor	25 W (Windows® 10 64-bit)
		Without DreamColor	16.8 W (Windows® 10 64-bit)
	Max Operating Power	< 200 W	
Temperature	Operating	32° to 95° F (0° to 35° C)	
	Non-operating	-4° to 140° F (-20° to 60° C)	
Relative Humidity	Operating	10% to 90%, non-condensing	
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet t	oulb temperature
Shock	Operating	40 G, 2 ms, half-sine	
	Non-operating	200 G, 2 ms, half-sine	
<b>Random Vibration</b>	Operating	0.75 grms	
	Non-operating	1.50 grms	
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
Industry Standard	UL	Yes	
Certifications	CSA	Yes	
	FCC Compliance	Yes	
	ENERGY STAR®	Select models*	
	EPEAT®	Gold **	
	ICES	Planned	
	Australia /	Planned	
	NZ A-Tick Compliance		
	CCC	Planned	
	Japan VCCI Compliance	Planned	
	KC	Planned	
	BSMI	Planned	
	CE Marking Compliance	Planned	
	MIL STD 810G	Planned***	

\* Configurations of the HP ZBook Studio that are ENERGY STAR<sup>®</sup> qualified are identified as HP ZBook Studio G5 ENERGY STAR<sup>®</sup> on HP websites and on http://www.energystar.gov.

\*\* EPEAT<sup>®</sup> registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

\*\*\* MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires a optional HP Accidental Damage Protection Care Pack.

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

Technical Specifications – Displays

# DISPLAYS

15.6" diagonal FHD AG LED IPS, with Ambient light sensor (1920x1080) (400 nits)	Active Area (W × H) Dimensions (W × H) Weight Surface Treatment Contrast Ratio Refresh Rate Brightness*	344.16 x 193.59 350.96 x 216.75 370 g (max) Anti-glare 600:1 (typical) 60 Hz 400 nits typical	
	Pixel Resolution Backlight PPI Viewing Angle * All specifications represe performance may vary e		1920 x 1080 (FHD) RGB Stripe //Down/Up) (typical) ns provided by HP's component manufacturers; actual

HP Sure View Privacy	Active Area (W × H)	344.16 x 193.59	
Display 15.6" diagonal	<b>Dimensions</b> (W x H)	350.96 x 216.75	
FHD AG LED IPS(1920x1080) (650	Diagonal Size	15.6 in (39.6 cm)	
nits)	Weight	320 g (max)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	600:1 (typical)	
	Refresh Rate	120 Hz	
	Brightness*	650 nits typical	
	<b>Pixel Resolution</b>	Pitch	0.1793 x 0.1793 mm
		Format	1920 X 1080 (FHD)
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	141	
	Viewing Angle	85/85/85/85 (Left/Rig	ht/Down/Up) (typical)
	* All specifications repre performance may vary e		ons provided by HP's component manufacturers; actual

## Technical Specifications – Displays

HP DreamColor Display	Active Area (W × H)	344.2176 x 193.62	
15.6" diagonal UHD IPS	<b>Dimensions</b> (W × H)	350.96 x 217.45	
AG - 10 (8+2) bit	Diagonal Size	15.6 in (39.6 cm)	
color(3840x2160) (600 nits) 100% AdobeRGB	Weight	380 g (max)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	1200:1 (typical)	
	Refresh Rate	60 Hz	
	Brightness*	600 nits typical	
	<b>Pixel Resolution</b>	Format	3840 x 2160 (UHD)
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	282	
	Viewing Angle	85/85/85/85 (Left/R	light/Down/Up) (typical)
	* All specifications represented		ations provided by HP's component manufacturers; actua

performance may vary either higher or lower.

15.6" diagonal UHD IPS AG	Active Area (W × H)	344.2176 x 193.62	
LED with Ambient light	<b>Dimensions</b> (W × H)	350.96 x 216.95	
sensor (3840x2160) (400 nits)	Diagonal Size	15.6 in (39.6 cm)	
(304072100) (400 mt3)	Weight	320 g (max)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	1200:1 (typical)	
	Refresh Rate	60 Hz	
	Brightness*	400 nits typical	
	<b>Pixel Resolution</b>	Format	3840 x 2160 (UHD)
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	282	
	Viewing Angle	85/85/85/85 (Left/R	light/Down/Up) (typical)
	* All specifications repre performance may vary e		ations provided by HP's component manufacturers; actual

Technical Specifications – Storage and Drives

## **STORAGE AND DRIVES**

#### **Internal Storage**

2 TB 5400 rpm SATA Hard	Drive Weight	0.21 lbs ( 95 g)		
Disk Drive	Capacity	2 TB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate		600 MB/s	
		Synchronous (maximum)		
	Seek Time (typical reads, including	Single Track	1.5 ms	
	settling)	Average	13 ms	
		Maximum	32 ms	
	Cache	128 MB		
	Rotational Speed	5400 rpm		
	Logical Blocks	3,907,029,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]		
	Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA		
500 GB 7200 rpm SATA Hard	Drive Weight	0.21 lbs ( 95 g)		
Disk Drive	Capacity	500 GB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum)	600 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms ~ 2 ms	
	(typical reads, including	A	11 mc 17 mc	
		Average	11 ms ~ 13 ms	
	settling)	Average Maximum	18 ms ~ 22 ms	
		-		
	settling)	Maximum		
	settling) Cache	<b>Maximum</b> Up To 32 MB		
	settling) Cache Rotational Speed	<b>Maximum</b> Up To 32 MB 7200 rpm	18 ms ~ 22 ms	
	settling) Cache Rotational Speed Logical Blocks	<b>Maximum</b> Up To 32 MB 7200 rpm 976,773,168	18 ms ~ 22 ms [top cover temp]	

1 TB 7200 rpm SATA Hard	Drive Weight	0.21 lbs (95 g)	
Disk Drive	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85mm)	
	Interface		
		ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	
	<b>Seek Time</b> (typical reads, including	Single Track	1.5 ms
	settling)	Average	13 ms
	Cache	<b>Maximum</b> 128 MB	32 ms
	Rotational Speed	7200 rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C)	[ton cover temn]
	Features	ATA Security, S.M.A.R.T., N	
		, , , , , , , , , , , , , , , , , , ,	
500 GB Hybrid,	Drive Weight	0.20 lbs (92 g) ~ 0.21 lbs (9	95 g)
8 GB cache	Capacity	500 GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
	Seek Time	Single Track	2 ms
	(typical reads, including	Average	12 ms
	settling)	Maximum	22 ms
	Cache	Up to 64MB	
	<b>Rotational Speed</b>	5400 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [	case temp]
	Features	ATA Security, S.M.A.R.T., N	ICQ, Ultra DMA
1 TB Hybrid, 8 GB cache	Drive Weight	90g	
o ob cucile	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s
	Seek Time (typical reads, including	Single Track	1.5 ms
	settling)	Average	13 ms
	-	Maximum	32 ms
	Cache	Up to 128MB	
	Rotational Speed	5400 rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [	-
	Features	ATA Security, S.M.A.R.T., N	ICQ, Ultra DMA

2 TB Hybrid,	Drive Weight	90g		
8 GB cache	Capacity	2 TB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum)	600 MB/s	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including	Average	13 ms	
	settling)	Maximum	32 ms	
	Cache	Up to 128MB		
	<b>Rotational Speed</b>	5400 rpm		
	Logical Blocks	3,907,029,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]		
	Features	ATA Security, S.M.A.R.T., N	ICQ, Ultra DMA	
500 GB 7200 rpm SATA SED	Drive Weight	0.21 lbs (95g)		
FIPS* 140-2 compliant Hard	Capacity	500 GB		
Disk Drive	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum)	600 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including	Average	12 ms	
	settling)	Maximum	21 ms	
	Cache	32 GB		
	<b>Rotational Speed</b>	7200 rpm		
	Logical Blocks	976,773,168		
	<b>Operating Temperature</b>	32° to 140° F (0° to 60° C) [top cover temp]		
	Features	ATA Security; TCG Opal 2.x	, FIPS, S.M.A.R.T., NCQ, Ultra DMA	
	* FIPS-certified, hardware	rdware-based AES-256 encryption image.		

500 GB 7200 rpm SATA SED	Drive Weight	0.21 lbs (95g)	
Hard Disk Drive	Capacity	500 GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600 MB/s (Drive Capability)
	<b>Seek Time</b> (typical reads, including settling)	Single Track	1.5 ms
		Average	12 ms
		Maximum	21 ms
	Cache	32 MB	
	<b>Rotational Speed</b>	7200 rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [	case temp]
	Features	ATA Security, TCG Opal 2.x	, S.M.A.R.T., NCQ, Ultra DMA

	Interface	ATA-8, SATA 3.0 TLC	
	NAND Type Form-Factor (I/O)	2.5 inch	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s~ 560 MB/s	500 MB/s~ 525 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; DIPM; TRIM; DEVS	I P

1 TB SATA TLC Solid State	Drive Weight	0.17 lb (78 g)	
Drive (2.5"?)	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	NAND Type	TLC	
	Form-Factor (I/O)	2.5 inch	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s~ 560 MB/s	500 MB/s~ 530 MB/s
	Logical Blocks	2,000,409,264	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; DIPM; TRIM; DEVSL	Р

256 GB M2 Self-Encrypting	Drive Weight	0.02 lb (<10 g)	
Drive TLC Solid State Drive	Capacity	256 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Interface	ACS-3, SATA 3.2	
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	ATA-8, SATA 3.0	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s~ 560 MB/s	500 MB/s~ 530 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; TCG Opal 2.0, DIPM;	TRIM; DEVSLP

256 GB M.2 NVMe TLC Solid	Drive Weight	0.02 lb (<10 g)	
State Drive	Capacity	256 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Generation	Samsung PM961/ Toshiba XG5	
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		2580 MB/s~ 2600 MB/s	1000 MB/s~ 1100 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient t	temp]
	Features	ATA Security (Option),TRIM; L1.2	

## Technical Specifications – Storage and Drives

256 GB M.2 NVMe TLC SED	Drive Weight	0.02 lb (<10 g)	
Solid State Drive	Capacity	256 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Generation	Samsung PM961 SED Opal2/ Tos	hiba XG5 SED Opal2
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Interface	PCIe NVMe Gen3X4	
	Performance	Maximum Sequential Read	<b>Maximum Sequential Write</b>
		2580 MB/s~ 2600 MB/s	Up to 1000 MB/s
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security (Option); TCG Opal 2	2.0; TRIM; L1.2

#### 512 GB M.2 NVMe TLC Solid

State Drive
-------------

Drive Weight	0.02 lb (<10 g)		
Capacity	512 GB		
Height	0.09 in (2.3 mm)		
Width	0.87 in (22 mm)		
Generation	Samsung PM981 / Toshiba XG5		
NAND Type	TLC		
Form-Factor (I/O)	M.2 2280		
Interface	PCIe NVMe Gen3X4		
Performance	Maximum Sequential Read	Maximum Sequential Write	
	2800 MB/s~ 2900 MB/s	1000 MB/s~ 1800 MB/s	
Logical Blocks	1,000,215,215		
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security, TRIM; L1.2		

512 GB M.2 NVMe TLC Solid	Drive Weight	0.02 lb (<10 g)		
State Drive	Capacity	512 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM981 SED Opal2/ Tos	shiba XG5 SED Opal2	
	NAND Type			
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		2800 MB/s~ 2900 MB/s	1000 MB/s~ 1800 MB/s	
	Logical Blocks	1,000,215,215		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambie	nt temp]	
	Features	ATA Security (Option); TCG Opal	2.0 ; TRIM; L1.2	
1 TB, M.2 NVMe TLC Solid	Drive Weight	0.02 lb (<10 g)		
State Drive	Capacity	1 TB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM981 / Toshiba XG5		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		2900 MB/s~ 3000 MB/s	Up to 2000MB/s	
	Logical Blocks	2,000,409,264		
	<b>Operating Temperature</b>	32° to 158°F (0° to 70°C) [ambie	nt temp]	
	Features	ATA Security,TRIM; L1.2		
2 TB, M.2 NVMe TLC Solid	Drive Weight	0.02 lb (<10 g)		
State Drive	Capacity	2 TB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Toshiba XG5P		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		Up to 2900MB/s	Up to 2100 MB/s	
	Logical Blocks	3,907,029,168		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambie	nt temp]	
	Features	ATA Security,TRIM; L1.2		

\*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows<sup>®</sup> 10) disk is reserved for system recovery software.

Technical Specifications – Networking/Communications

# **NETWORKING/COMMUNICATIONS**

Intel® Dual Band Wireless- N 9560AC 802.11 a/b/g/n (2x2) WiFi + Bluetooth 5.0 Combo Adaptor*	Wireless LAN Standards Interoperability Frequency Band	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi certified 802.11b/g/n	2.402 - 2.482 GHz <b>Note:</b> The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
		802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz <b>Note:</b> No support for this band in Indonesia
	Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 4 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 4 802.11n: MCS 0 ~ MCS 15 (20) 802.11ac : MCS0 ~ MCS9, (15)	48, 54 Mbps
	Modulation	Direct Sequence Spread Spec CCK, BPSK, QPSK, 16-QAM, 64	
	Security <sup>1</sup>	<ul> <li>CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM</li> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mod only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>WAPI</li> </ul>	
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point F	Reauired)
	Roaming		ng between band Access Points
	Output Power <sup>2</sup>	802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +14d 802.11n HT40(2.4GHz) : +12d 802.11n HT20(5GHz) : +14dB 802.11n HT40(5GHz) : +12dB	IBm minimum m minimum
	Power Consumption	Transmit: 2.0 Watts Receive: 1.6 Watts Idle mode: 180 mW (WLAN As Idle mode: 50 mW (WLAN una Connect Standby: 10 mW (W Radio disabled: 5 mW	issociated)

## Technical Specifications – Networking/Communications

Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum		
Antenna Type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm		
Weight	Type 2230 : 2.8g Or Type 1630 : 2g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating         0 to 10,000 ft (3,048 m)           Non-operating         0 to 50,000 ft (15,240 m)		
LED Activity	LED Amber - Radio OFF; LED White - Radio ON		

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

\* Wireless access point and internet service required. Availability of public wireless access points limited.

#### HP Integrated Module with Bluetooth 4.2 Wireless Technology

Bluetooth Specification Frequency Band	4.2 Compliant 2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

## Technical Specifications – Networking/Communications

#### **Receiver Sensitivity**

•	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	p/4-DQPSK 8DPSK	-80 dBm -80 dBm	<u>-70 dBm</u> -70 dBm	
Power Consumption	Peak (Tx) 330 mW	00 dBm	70 dBm	
rower consumption	Peak (Rx) 230 mW			
	Selective Suspend 17 n	nW		
Range	Legacy Up to 33 ft (10 m)			
	BLE Up to 99 ft (30 m)			
Electrical Interface	USB 2.0 compliant			
Bluetooth Software	Microsoft Windows® Bl	uetooth Software		
Supported				
Link Topology	Point to Point, Multipoi	nt Pico Nets up to 7 sl	aves	
Security	Full support of Bluetooth Security Provisions			
Power Management	Microsoft Windows® AG	CPI, and USB Bus Supp	ort	
	Self-configurable to op including Standby, Holo	•	ation in all operating mode	
Certifications	All necessary regulator	y approvals for suppo	orted countries, including:	
	FCC (47 CFR) Part 15C, Section 15.247 & 15.249			
	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950			
	UL, CSA, and CE Mark			
<b>Bluetooth Profiles</b>	Serial Port Profile (SPP)	1		
Supported	Service Discovery Appl	ication Profile (SDAP)		
	Dial-Up Networking (DUN)			
	Generic Object Exchange Profile (GOEP)			
	Object Push Profile (OPP) Hard Copy Cable Replacement (HCRP)			
	Personal Area Networking Profile (PAN)			
	Human Interface Device Profile (HID)			
	Hands Free Profile (HFP)			
	Advanced Audio Distribution Profile (A2DP)			
	Audio Video Remote Co	ontrol Profile (AVRCP)		

# Technical Specifications – Networking/Communications

	-			
Near Field	Controller	NFC Mirage WNC XRAV-1 (	NXP NPC300 I2C 10mmx17mm)	
Communications (NFC) Controller (optional)	Supports	Windows 8, Proximity Events		
controtter (optional)		Windows 7, PC/     NEC Forum Con		
		<ul> <li>NFC Forum Con</li> <li>Near Field Comr</li> </ul>	nunications Controller	
	Dimensions (L x W x H)	Module 25 mm by 10 mm		
	Chipset	NPC100	by 2.0 mm	
	System interface	120		
	NFC RF standards	standards ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092		
	NFC KF Stallualus	ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2		
	NFC Forum Support Tag	Type 1, Type 2, Type3 and	Type 4, NFCIP-1 and NFCIP-2	
	Reader		C 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE Fire FeliCa Jewel and Topaz cards	
	Card Emulation	(PICCVICC)		
	Mode	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa		
	Frequency	13.56 MHz		
	NFC Modes Supported	Reader/Writer, Peer-to-Peer		
	Raw RF Data Rates	106, 212, 424, 848 kbps		
	Operating temperature	0°C to 70°C		
	Storage temperature	-20°C to 125°C		
	Humidity	10-90% operating 5-95% non-operating		
	Supply Operating voltage	2.97 to 5.5 Volts		
	I/O Voltage	1.8V or 3.3V		
	<b>Power Consumption</b>	Booster enable,	VBAT= 3.3V,	
		VCC_BOOST = 5V) Mode Power Consumption,	Typical <sup>2</sup> Polling 7.3 mA Detected Test Tag Type 1 Total 283.8 mA Net Module 236.8 mA Detected Test Tag Type 2 Total 288.8 mA Net Module 241.8 mA Detected Test Tag Type 3 Total 287.7 mA Net Module 240.7 mA Detected Test Tag Type 4 Total 282.3 mA Net Module 235.3 mA	
	Antenna connector	0.5mm pitch, 7 connector	FPC. Antenna matching is external to module.	
2. Ai m			or UICC support nsumption is dependent on NFC antenna and and on the particular polling sequence and period	

Technical Specifications – Audio/Multimedia

## **AUDIO/MULTIMEDIA - BANG & OLUFSEN**

Hardware	Implementation	Synaptics CX8400 with two NXP TFA9891 discrete smart amplifiers
	Function Key Volume Controls	Volume up, volume down, and mute
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes, three digital microphone array when equipped with optional webcam
Audio Output Quality	Frequency Response	20 Hz - 20 kHz
nuulo output quality	Signal to Noise Ratio	106dB (DAC), 102dB (ADC)
	Total Harmonic Distortion	
	Noise Floor	-110 dB
	Play Sampling Rate(s)	Up to 192kHz
	Record Sampling Rate(s)	Up to 96kHz
	DAC	16, 20 or 24-bit
	ADC	16, 20 or 24-bit
Internal Stereo Speaker	Power Rating	1 Watt/per speaker
	Impedance	8 ohms/per speaker

## Technical Specifications – Power

# POWER

HP 150W Slim Smart AC	Dimensions	6.02 x 2.60 x .87 in ((153 x	( 66 v 22 mm)
Adapter	Weight	0.71 lbs (320 g)	
	-	100 to 240 VAC	
	Input	Input Efficiency	88% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	2.9 A at 90 VAC, 1.45 A at 180 VAC
	Output	Output power	150W
	σατρατ	DC output	19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<16A, Over voltage protection- 29V max
		output current linnt	automatic shutdown
	Connector	3 pin/grounded, mates wit	
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)
		Altitude	0 to 10,000 ft (0 to 3,048 m)
		Humidity	20% to 80%
		Storage Humidity	10% to 90%
			5022 Class B, FCC Class B, CISPR22 Class B, CCIB,
			200,000 hours at 25°C ambient condition.
HP Long Life 4-cell	Dimensions (H × W × L)	7.9 x 3.49 x 0.32 in (20.08	
Prismatic Battery (64	Dimensions (H x W x L) Weight (max)		
Prismatic Battery (64		7.9 x 3.49 x 0.32 in (20.08	
Prismatic Battery (64	Weight (max)	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g)	
Prismatic Battery (64	Weight (max) Cells/Type	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer	x 8.86 x 0.81cm)
Prismatic Battery (64	Weight (max) Cells/Type	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage	x 8.86 x 0.81cm) 15.4V
HP Long Life 4-cell Prismatic Battery (64 WHr)	Weight (max) Cells/Type	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity	x 8.86 x 0.81cm) 15.4V 4.155Ah
Prismatic Battery (64	Weight (max) Cells/Type Energy	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh
Prismatic Battery (64	Weight (max) Cells/Type Energy	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity Operating (Charging)	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh 32° to 113° F (0° to 45° C)
Prismatic Battery (64	Weight (max) Cells/Type Energy	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity Operating (Charging) Operating (Discharging)	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh 32° to 113° F (0° to 45° C) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C)
Prismatic Battery (64	Weight (max) Cells/Type Energy Temperature	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity Operating (Charging) Operating (Discharging) Non-operating System in OFF or Standby	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh 32° to 113° F (0° to 45° C) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C)
Prismatic Battery (64	Weight (max) Cells/Type Energy Temperature	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity Operating (Charging) Operating (Discharging) Non-operating System in OFF or Standby Mode	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh 32° to 113° F (0° to 45° C) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C) 3 hours
Prismatic Battery (64	Weight (max) Cells/Type Energy Temperature Battery Re-Charge Time	7.9 x 3.49 x 0.32 in (20.08 0.619lb (281g) 4-cell; Polymer Voltage Amp-hour capacity Watt-hour capacity Operating (Charging) Operating (Discharging) Non-operating System in OFF or Standby Mode System ON	x 8.86 x 0.81cm) 15.4V 4.155Ah 64Wh 32° to 113° F (0° to 45° C) 14° to 140° F (-10° to 60° C) -4° to 140° F (-20° to 60° C) 3 hours

HP Long Life 6-cell	<b>Dimensions</b> ( $H \times W \times L$ )	13.02 x 3.51 x 0.319 in (33	08 x 8 92 x0 81cm)
Prismatic Battery (96 WHr)	Weight (max)	1.12lb (420g)	.00 x 0.52 x0.0 rcm/
	-	5	
	Cells/Type	6-cell; Polymer	
	Energy	Voltage	11.55V
		Amp-hour capacity	8.31Ah
		Watt-hour capacity	95Wh
	Temperature	Operating (Charging)	32° to 122°F (0° to 50° C)
		Operating (Discharging)	14° to 140°F (-10° to 60° C)
		Non-operating	>140° F (>60° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	3 hours
		System ON	3 to 5 hours
	Fuel Gauge LED	No LED	
	Warranty*	3 year	
	* 3-year platform warran	ty is required for a 3-year Lo	ng Life Battery warranty.

Technical Specifications – Environmental

## **ENVIRONMENTAL DATA**

Eco-Label Certifications & declarations	<ul> <li>with one or more of these marks:</li> <li>IT ECO declaration</li> <li>US ENERGY STAR®</li> <li>US Federal Energy Managem</li> </ul>	he process of being certified to the f ent Program (FEMP) he United States. See http://www.ej	
System Configuration	The configuration used for the Ene model is based on a "Typically Con	rgy Consumption and Declared Nois figured Notebook"?.	e Emissions data for the N
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	11.20 W	10.51 W	11.24 W
Normal Operation (Long idle)	6.70 W	6.30 W	6.37 W
Sleep	1.13 W	1.12 W	1.14 W
Off	0.41 W	0.43 W	0.42 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR<sup>®</sup> compliant product if offered within the moc computers marked with the ENERGY STAR<sup>®</sup> Logo are compliant with the applicable U.S. Environn Protection Agency (EPA) ENERGY STAR<sup>®</sup> specifications for computers. If a model family does not ENERGY STAR<sup>®</sup> compliant configurations, then energy efficiency data listed is for a typically conf featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows<sup>®</sup> operating

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	38 BTU/hr	36 BTU/hr	38 BTU/hr
Normal Operation (Long idle)	23 BTU/hr	22 BTU/hr	22 BTU/hr
Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
Off	1.4 BTU/hr	1 BTU/hr	1 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is one hour.

Declared Noise Emissions	Sound Power	Sound Pressure
(in accordance with	(L <sub>WAd</sub> , bels)	(L <sub>pAm</sub> , decibels)
ISO 7779 and ISO 9296)		
Typically Configured – Idle	3.2	22
Fixed Disk - Random writes	3.2	21
Longevity and Upgrading	This product can be upgraded, possibly extending its u	seful life by several years. Upgradea

This product can be upgraded, possibly extending its useful life by several years. Upgradeable fea and/or components contained in the product may include:

- 2 USB ports
- 2 Thunderbolt<sup>TM</sup> 3 ports
- 1 2.5"? Storage Bay Drive
- 2 M.2 SATA SED Solid State Drives
- 2 SODIMM memory slots

## Technical Specifications – Environmental

		DMI 2.0 port re available throughout the warranty period and or for up to "5"	? years after the		
Batteries	This battery(s)	) in this product comply with EU Directive 2006/66/EC			
	Mercury g	d in the product do not contain: reater the1ppm by weight greater than 20ppm by weight			
	Battery type: I	CR2032 (coin cell) Lithium 6-cell high capacity Lithium-Ion battery (optional 8 cell availab	ıle)		
Additional Information	- 2011/6		. ,		
	(WEEE)	P product is designed to comply with the Waste Electrical and Directive - 2002/96/EC. Doduct is in compliance with California Proposition 65 (State of Compliance)	•		
		nd Toxic Enforcement Act of 1986). oduct is in compliance with the IEEE 1680 (EPEAT) standard a reat net	at the Gold level		
	<ul> <li>Plastics ISO1043</li> </ul>	parts weighing over 25 grams used in the product are marked 3.	l per ISO11469		
		oduct contains 0.0% post-consumer recycled plastic (by wt.) oduct is 95.6% recycle-able when properly disposed of at end o	of life.		
Packaging Materials	External:	PAPER/Corrugated	383		
	Internal:	PLASTIC/Polyethylene Expanded - EPE	90 g		
		PLASTIC/Polyethylene low density - LDPE	10 g		
		PLASTIC/Polypropylene - PP	5 g		
	The plastic pa	ckaging material contains at least 81.5% recycled content.			
	The corrugate	ed paper packaging materials contains at least 80 % recycled cont	ent.		
Material Usage	General Specifi	oes not contain any of the following substances in excess of regu ication for the Environment at com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):	latory limits (ref		
	nttp.//www.np	.com/npinio/globalchizenship/environment/put/gse.put/.			
	<ul> <li>Asbesto</li> </ul>				
		Azo Colorants Brominated Flame Retardants - may not be used as flame retarda	nts in plastics		
	Cadmiur	-			
		ted Hydrocarbons			
	<ul> <li>Chlorina</li> <li>Formald</li> </ul>	ted Paraffins ebyde			
		ated Diphenyl Methanes			
	Lead carbonates and sulfates				
		d Lead compounds : Oxide Batteries			
		finishes must not be used on the external surface designed to be f	frequently handl		
	by the u	ser.			
		epleting Substances minated Biphenyls (PBBs)			
	-	minated Biphenyl Ethers (PBBEs)			
	<ul> <li>Polybror</li> </ul>	ninated Biphenyl Oxides (PBBOs)			
	<ul> <li>Polychlo</li> </ul>	prinated Biphenyl (PCB)			

## Technical Specifications – Environmental

reennear Speemeations	Environmentat
	<ul> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has bee removed from most applications.</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packa materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	HP Inc.offers end-of-life HP product return and recycling programs in many geographic areas. To your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sal Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information of the same set of the sa
	each product type for use by treatment facilities. This information (product disassembly ins is posted on the HP Inc. web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions used by recyclers and other WEEE treatment facilities as well as HP OEM customers who and re-sell HP equipment.
HP Inc. Corporate Environmenta Information	al For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

# **COUNTRY OF ORIGIN**

China

# Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Display	HP DreamColor Z31x Studio Display	Z4Y82A8
Memory	HP 4GB DDR4-2666 SODIMM	TBD
•	HP 8GB DDR4-2666 SODIMM	TBD
	HP 16GB DDR4-2666 SODIMM	TBD
	HP 8GB DDR4-2666 ECC SODIMM	TBD
	HP 16GB DDR4-2666 ECC SODIMM	TBD
Cases	HP 15.6 Business Top Load- Refresh	2SC66AA
	HP Exec Black Leather 15.6 Top Load	1LG83AA
	HP Slim Ultrabook Messenger (up to 15.6" x .88"/22/5mm)	F3W14AA
	HP Slim Ultrabook Backpack (up to 15.6" x .88"/22/5mm)	F3W16AA
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
Docking	HP USB-C Universal Dock	1MK33AA
	HP USB-C Mini Dock	1PM64AA
	HP Thunderbolt <sup>™</sup> Dock 230W G2	2UK38AA
	HP Thunderbolt Dock Audio	3AQ21AA
	HP USB-C Dock G4	3FF69AA#xxx
	HP TB Dock G2 w/Combo Cable	3TR87AA#xxx
	HP Travel Hub	TOK30AA
	HP 3005pr USB 3.0 Port Replicator w∕ USB-C <sup>™</sup> Adapter	Y4H06AA
Input/Output -	HP Wireless Premium Mouse	1JR31AA
Mice	HP USB Premium Mouse	1JR32AA
	HP Slim Bluetooth Mouse	F3J92AA#xxx
	HP USB Travel Mouse	G1K28AA#xxx
	HP Comfort Grip Mouse	H2L63AA
	HP X4000 Bluetooth Mouse	H3T50AA#xxx
	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Wireless (Link-5) Keyboard	T6U20AA
Power Adapters	HP 150W Slim Smart AC Adapter	4SC18UT#xxx
	HP 65W Slim A/C Adapter w/USB	H6Y82AA
	HP 90W Slim A/C Adapter w/USB	Нбүвзаа
	HP 90W Slim Auto Combo AC Adapter w/USB	H6Y84AA
	HP 90W Smart AC Adapter	H6Y90AA
	· ·	

Adapters	HP HDMI to DVI adapter	F5A28AA
-	HDMI to VGA Adapter	H4F02AA
	USB 3.0 to RJ45	N7P47AA
	HP USB-C <sup>™</sup> to VGA Adapter	N9K76AA
	USB-C to RJ45	V7W66AA
	HP USB-C <sup>TM</sup> to USB Hub	Z6A00AA
Storage - Exter	nal HP 256GB M2 NVME PCIe SSD (2280)	V3K66AA
Storage	HP 512GB M2 NVME PCIe SSD (2280)	V3K67AA
	HP 256GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU87AA
	HP 512GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU88AA
	HP External USB DVDRW Drive	F2B56AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Dual Head Keyed Cable Lock	1AJ41AA
	HP Docking Station Cable Lock	AU656AA#XXX
	HP Keyed Cable Lock	T0Y14AA
	HP Combination Lock	T0Y15AA
	HP Essential Combination Lock	T0Y16AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP Dual Head Cable Lock (Non-Master key)	T1A64AA
	HP Dual Head Cable Lock (Master Key)	T1A65AA
	HP 3 year Next business day onsite Hardware Support w/Accidental Damage Protection-G2 for Notebooks	UF631E
Collaboration	HP Elite Presenter Mouse	2CE30AA#xxx
	HP UC Conferencing Keyboard	K8P74AA#xxx
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP USB Collaboration Keyboard	Z9N38AA
	HP Wireless Collaboration Keyboard	Z9N39AA#xxx
	HP Wireless Premium Keyboard	Z9N41AA#xxx

## Summary of Changes

Date of change:	Version History:		Description of change:
April 6, 2018	From v1 to v2	Changed	Weight section
June 11, 2018	From v2 to v3	Update	Operating system, Processor, Graphics, Storage, Wights & Dimensions

title

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